1 Introduction
TIDA-00539 is a high power four-pair solution for Power-over-Ethernet (PoE) applications requiring power in excess as defined in the current IEEE 802.3at standard. It is compliant with Cisco UPOE Forced Four-Pair designs.

2 Configurable features

1.1 Features
- Excellent efficiency, driven, synchronous flyback design.
- Forced Four-Pair UPOE compliant
- 19V @ 2.3A DC output (2.9A capable)

1.2 Applications
- Universal Power Over Ethernet (UPOE) Compliant Devices
- Video and VoIP telephones
- Multiband access points
- Security cameras
- Pico-base stations
3 Electrical specifications

TIDA-00539 Electrical and Performance Specifications

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Power Interface</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Voltage</td>
<td>Applied to the power pins of connectors J1 or J3</td>
<td>42.5</td>
<td>-</td>
<td>57</td>
<td>Volts</td>
</tr>
<tr>
<td>Operating Voltage (¹)</td>
<td>After start up.</td>
<td>30</td>
<td>-</td>
<td>57</td>
<td></td>
</tr>
<tr>
<td>Input UVLO, POE input J1 (¹)</td>
<td>Rising input voltage</td>
<td>-</td>
<td>-</td>
<td>40</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Falling input voltage</td>
<td>30</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>Detection voltage (¹)</td>
<td>@ device terminals</td>
<td>1.4</td>
<td>-</td>
<td>10.1</td>
<td></td>
</tr>
<tr>
<td>Classification voltage (¹)</td>
<td>@ device terminals</td>
<td>11.9</td>
<td>-</td>
<td>23.0</td>
<td></td>
</tr>
<tr>
<td>Classification current (¹)</td>
<td>Rclass = 63.4 ohms</td>
<td>38</td>
<td>-</td>
<td>42</td>
<td>mA</td>
</tr>
<tr>
<td>Inrush current-limit (¹)</td>
<td></td>
<td>100</td>
<td>-</td>
<td>180</td>
<td></td>
</tr>
<tr>
<td>Operating current-limit (¹)</td>
<td></td>
<td>850</td>
<td>-</td>
<td>1200</td>
<td></td>
</tr>
<tr>
<td><strong>DC/DC Converter</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Voltage</td>
<td>42.5 ≤ Vin ≤ 57V, ILOAD ≤ ILOAD (max)</td>
<td>19V output</td>
<td>19.01</td>
<td>19.04</td>
<td>19.07</td>
</tr>
<tr>
<td>Output Current</td>
<td>42.5 ≤ Vin ≤ 57V</td>
<td>19V output</td>
<td>-</td>
<td>-</td>
<td>2.9</td>
</tr>
<tr>
<td>Output ripple voltage, pk-to-pk</td>
<td>Vin = 48V, ILOAD = 2.9A</td>
<td>19V output</td>
<td>-</td>
<td>225</td>
<td>-</td>
</tr>
<tr>
<td>Efficiency, dc-dc converter</td>
<td>Vin = 48V, ILOAD = 2.9A</td>
<td>19V output</td>
<td>-</td>
<td>93</td>
<td>-</td>
</tr>
<tr>
<td>Efficiency, end-to-end</td>
<td>Vin = 48V, ILOAD = 2.9A</td>
<td>19V output</td>
<td>-</td>
<td>90</td>
<td>-</td>
</tr>
<tr>
<td>Switching frequency</td>
<td></td>
<td>225</td>
<td>-</td>
<td>270</td>
<td>kHz</td>
</tr>
</tbody>
</table>
4 Efficiency

Vin = 48V

Vin = 42.5V

Vin = 57V
5 Load Regulation

Load regulation is less than +/-20mV.

6 Line Regulation
7 Start up

The below graph shows startup of the converter and subsequent current starting between the two PDs for a 26W output load.
8 Switch Node Waveforms

The below waveform shows the primary FET gate drive voltage and VDS voltage at 48V input and 2.9A output current.

The below waveform shows the synch FET gate drive voltage and VDS voltage at 48V input and 2.9A output current.
9 Output Ripple Voltage

The 19V output ripple voltage is shown in the scope plot below. The waveform was taken with the output loaded to 2.9A. Vin = 48V.

[Scope plot image]

10 Load Delay Circuit

IEEE standard requires at startup, the PD does not consume more than 13W for 80ms. Typically, there are provisions (startup delays) in the end-product load that satisfies this requirement. Resistive loads are typically used for evaluation. The main purpose of the Load Delay Circuit is to delay a high-current resistive load and prevent PSE hiccup during startup.

The 19V output voltage is shown in the scope plot below. There is 230ms delay before the load current is enabled. This can be adjusted through C39. The waveform was taken with the output loaded to 2.4A and the Load Delay Circuit enabled. Vin = 48V.
11 Load Transients
The scope plots below show the 19V output voltage when the load current is pulsed from 0.29 to 2.9A at a 300A/ms slew rate. Vin = 48V.

12 Control Loop Gain / Stability
The table below shows the loop gain and phase margin. The output was loaded to 2.9A with a resistive load.

<table>
<thead>
<tr>
<th>Input voltage</th>
<th>48VDC</th>
</tr>
</thead>
<tbody>
<tr>
<td>Gain/Phase</td>
<td>Crossover</td>
</tr>
<tr>
<td>TIDA-00539</td>
<td>7kHz</td>
</tr>
</tbody>
</table>
TIDA-00539 UPOE High-Efficiency Flyback Converter (19V/2.3A) for Forced 4-Pair PoE PD Applications
13 Thermal
The image below shows the thermal performance of TIDA-00539 at full load with 48V input.
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